

MOSFET

OptiMOS[™] 6 Power-Transistor, 100 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM) Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

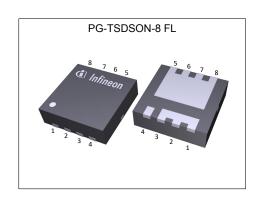
- MSL 1 classified according to J-STD-020



Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Hoy 1 of 1011 marries 1 an annother							
Parameter	Value	Unit					
$V_{ extsf{DS}}$	100	V					
$R_{ extsf{DS(on),max}}$	8.04	mΩ					
I _D	75	A					
Qoss	35	nC					
Q _G (0V10V)	19	nC					
Q _{rr} (100A/µs)	31	nC					











Type / Ordering Code	Package	Marking	Related Links
ISZ080N10NM6	PG-TSDSON-8 FL	080N1N6	-

OptiMOS[™] 6 Power-Transistor, 100 V



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OptiMOS[™] 6 Power-Transistor, 100 V ISZ080N10NM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Or week at		Value	S	11:4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - - -	- - -	75 53 48 13	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50°C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	300	Α	T _A =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	20	Α	T _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	283	mJ	$I_{\rm D}$ =7 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	100 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Dovomotor	Cumbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.77	1.5	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.3	2.8	3.3	V	V _{DS} =V _{GS} , I _D =36 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C ¹⁾
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	7.1 8.6	8.04 10	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =8 V, I _D =10 A
Gate resistance	R _G	0.6	1.2	1.8	Ω	-
Transconductance	g fs	15	30	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Parameter	Complete	Values			11:4	Nata / Tank Oamalikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	1400	1800	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	310	390	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	9	13	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	6.4	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	1.5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	10.7	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4.3	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =10 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	O. mak al	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q_{gs}	-	6.4	8.5	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold ¹⁾	$Q_{g(th)}$	-	3.9	4.9	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	3.4	5.1	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	5.9	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	19	24	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.6	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	17	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	35	44	nC	V _{DS} =50 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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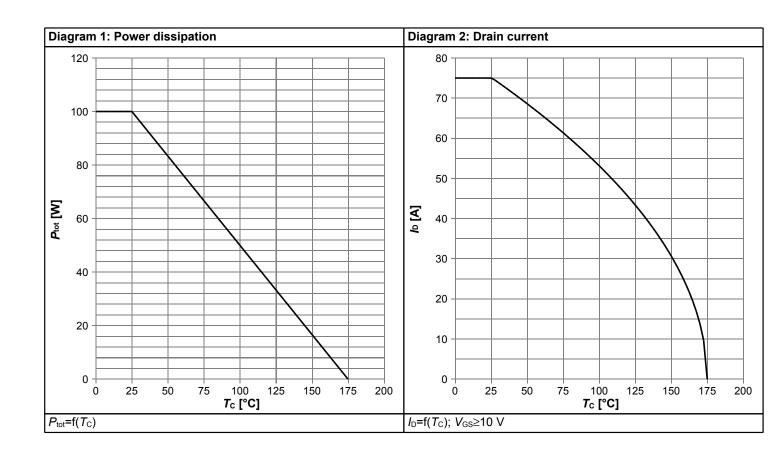


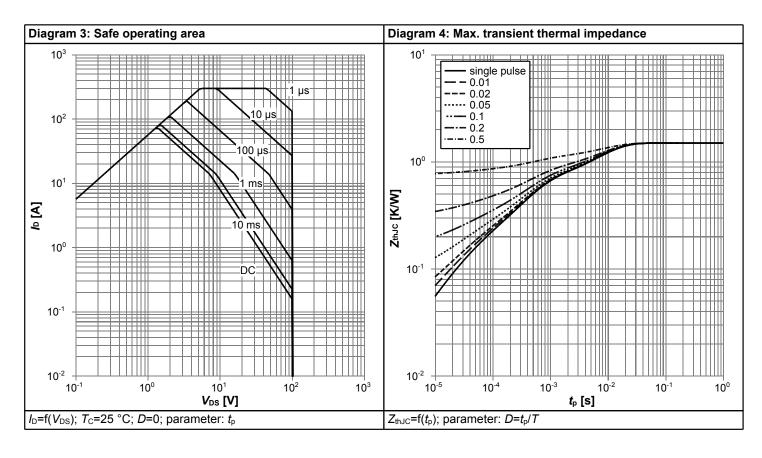
Table 7 Reverse diode

Dougnatou	Comple el		Values			Nata / Tank Canadition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	75	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	300	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.82	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	31.5	47	ns	V _R =50 V, I _F =10 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	31	46.5	nC	V _R =50 V, I _F =10 A, di _F /dt=100 A/μs
Reverse recovery time ¹⁾	t _{rr}	-	18	27	ns	V_R =50 V, I_F =10 A, di_F/dt =1000 A/ μ s
Reverse recovery charge ¹⁾	Qrr	-	140	210	nC	V _R =50 V, I _F =10 A, dI _F /dt=1000 A/µs

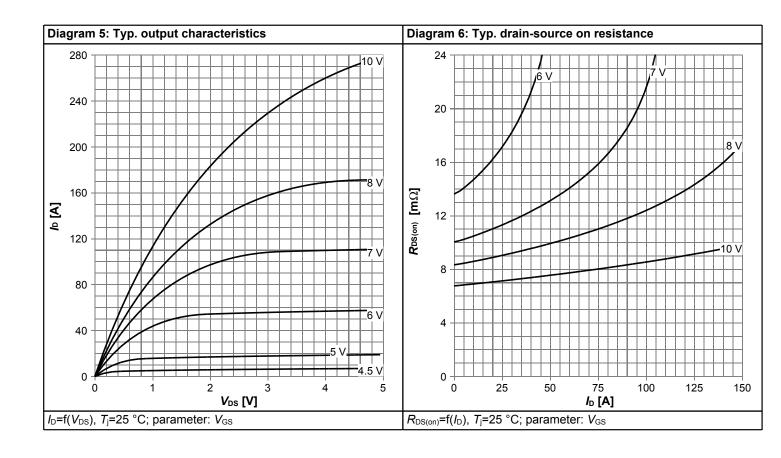


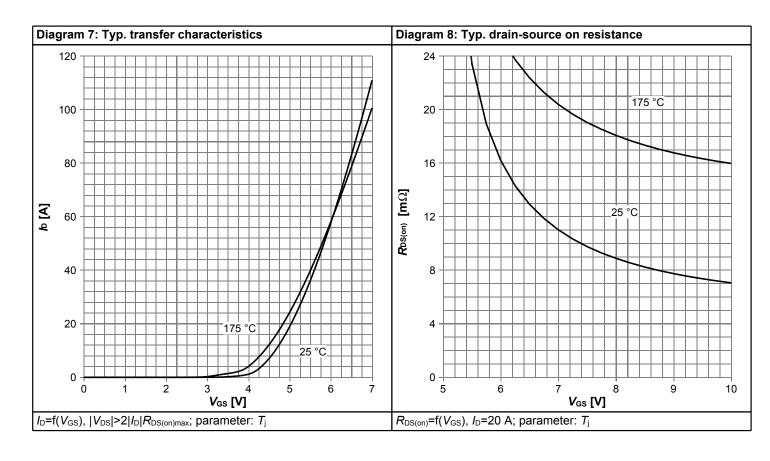
4 Electrical characteristics diagrams



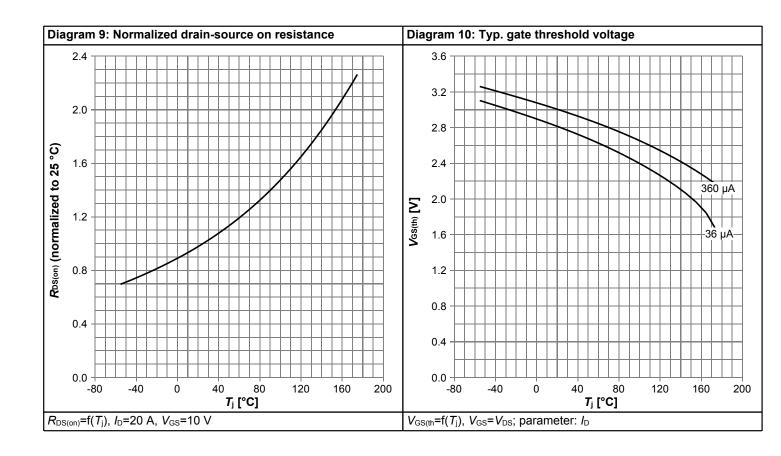


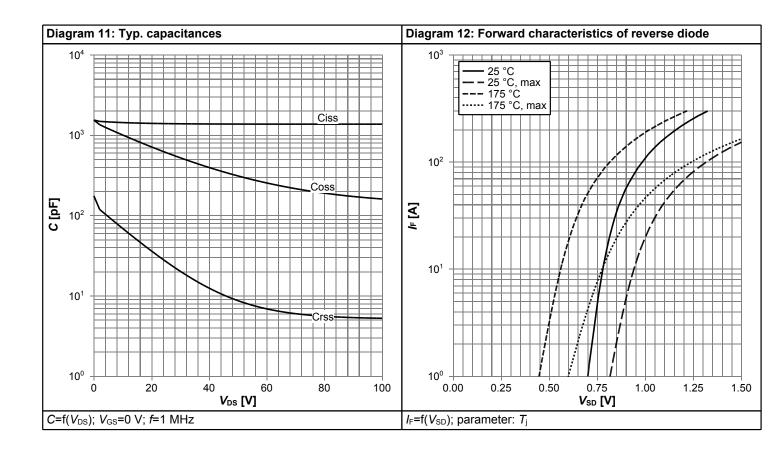




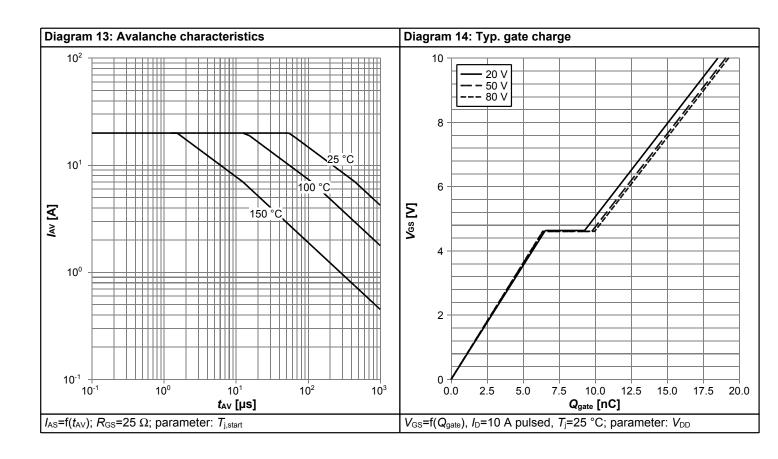


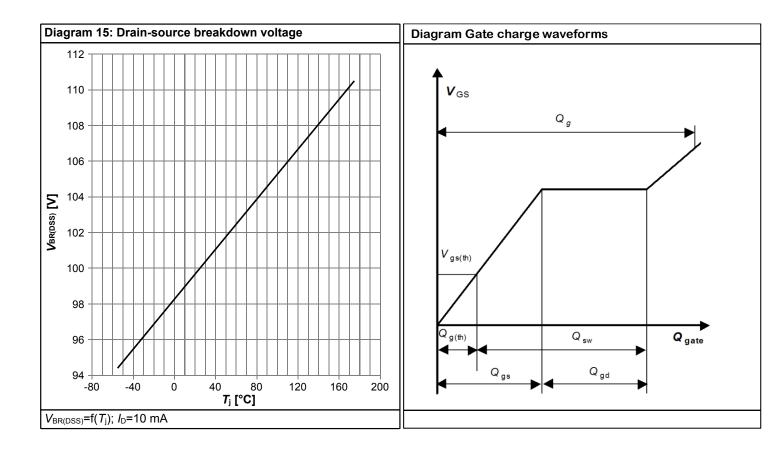






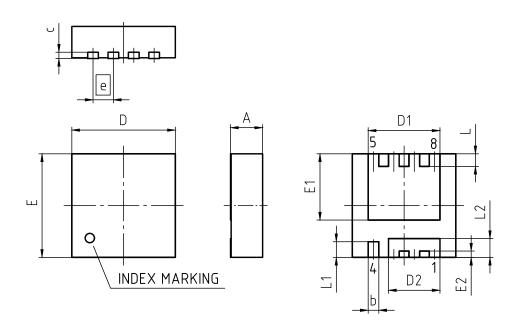








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	PG-TSDSON-8-U03				
REVISION: 03	DATE:	20.10.2020				
DIMENSIONS	MILLIN	IETERS				
DIMENSIONS	MIN.	MAX.				
Α	0.90	1.10				
b	0.24	0.44				
С	(0	.20)				
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.65					
L	0.30	0.50				
L1	0.40	0.60				
L2	0.50	0.70				
aaa	0.0	06				

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

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Revision History

ISZ080N10NM6

Revision: 2023-02-10, Rev. 2.2

Previous Revision

Revision	Date Subjects (major changes since last revision)					
2.0	2021-07-05	Release of final version				
2.1	2021-07-20	Update IAS and Diagram 10				
2.2	2023-02-10	Update SOA Diagram				

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